Product data sheet

1. General description

The 74LV4051 is an 8-channel analog multiplexer/demultiplexer with three digital select inputs (S0 to S2), an active-LOW enable input (\overline{E}), eight independent inputs/outputs (Y0 to Y7) and a common input/output (Z). It is a low-voltage Si-gate CMOS device that is pin and function compatible with 74HC4051 and 74HCT4051. With \overline{E} LOW, one of the eight switches is selected (low impedance ON-state) by S0 to S2. With \overline{E} HIGH, all switches are in the high-impedance OFF-state, independent of S0 to S2.

 V_{CC} and GND are the supply voltage pins for the digital control inputs (S0 to S2, and \overline{E}). The V_{CC} to GND ranges are 1.0 V to 6.0 V. The analog inputs/outputs (Y0 to Y7, and Z) can swing between V_{CC} as a positive limit and V_{EE} as a negative limit. $V_{CC} - V_{EE}$ may not exceed 6.0 V. For operation as a digital multiplexer/demultiplexer, V_{EE} is connected to GND (typically ground).

2. Features and benefits

- Optimized for low-voltage applications: 1.0 V to 6.0 V
- Accepts TTL input levels between $V_{CC} = 2.7$ V and $V_{CC} = 3.6$ V
- Low ON resistance:
 - 145 Ω (typical) at V_{CC} V_{EE} = 2.0 V
 - 80 Ω (typical) at V_{CC} V_{EE} = 3.0 V
 - 60 Ω (typical) at V_{CC} V_{EE} = 4.5 V
- Logic level translation:
 - ◆ To enable 3 V logic to communicate with ±3 V analog signals
- Typical 'break before make' built in
- ESD protection:
 - ◆ HBM JESD22-A114E exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from –40 °C to +85 °C and from –40 °C to +125 °C



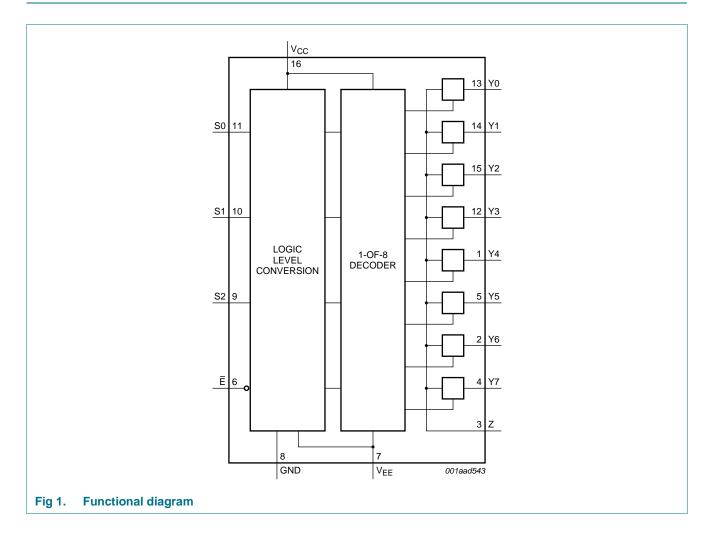
8-channel analog multiplexer/demultiplexer

3. Ordering information

Table 1. Ordering information

Type number	Package									
	Temperature range	Name	Description	Version						
74LV4051N	–40 °C to +125 °C	DIP16	plastic dual in-line package; 16 leads (300 mil)	SOT38-4						
74LV4051D	–40 °C to +125 °C	SO16	plastic small outline package; 16 leads; body width 3.9 mm	SOT109-1						
74LV4051DB	–40 °C to +125 °C	SSOP16	plastic shrink small outline package; 16 leads; body width 5.3 mm	SOT338-1						
74LV4051PW	–40 °C to +125 °C	TSSOP16	plastic thin shrink small outline package; 16 leads; body width 4.4 mm	SOT403-1						
74LV4051BQ	–40 °C to +125 °C	DHVQFN16	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body $2.5 \times 3.5 \times 0.85$ mm	SOT763-1						

4. Functional diagram



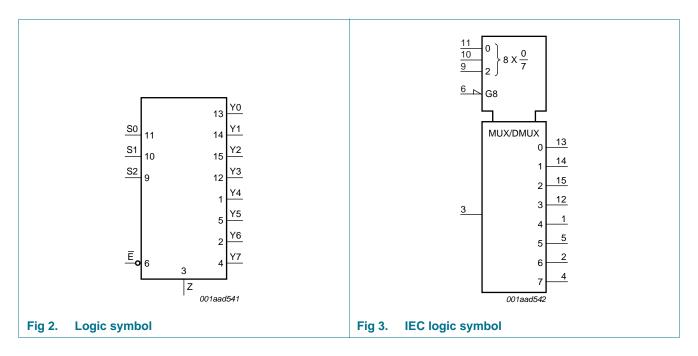
74LV4051

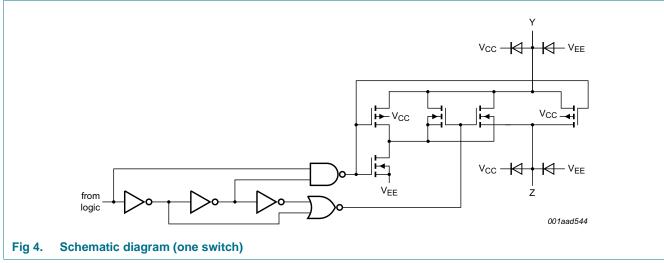
2 of 27

NXP Semiconductors

74LV4051

8-channel analog multiplexer/demultiplexer

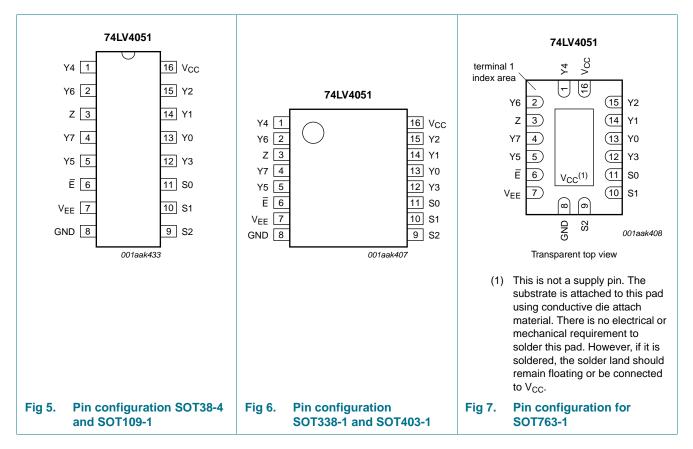




8-channel analog multiplexer/demultiplexer

Pinning information 5.

5.1 Pinning



5.2 Pin description

Table 2. Pin description		
Symbol	Pin	Description
Ē	6	enable input (active LOW)
V _{EE}	7	supply voltage
GND	8	ground supply voltage
S0, S1, S2	11, 10, 9	select input
Y0, Y1, Y2, Y3, Y4, Y5, Y6, Y7	13, 14, 15, 12, 1, 5, 2, 4	independent input or output
Z	3	common output or input
V _{CC}	16	supply voltage

74LV4051

8-channel analog multiplexer/demultiplexer

6. Functional description

6.1 Function table

 Table 3.
 Function table^[1]

Input				Channel ON
Ē	S2	S1	S0	
L	L	L	L	Y0 to Z
L	L	L	Н	Y1 to Z
L	L	Н	L	Y2 to Z
L	L	Н	Н	Y3 to Z
L	Н	L	L	Y4 to Z
L	Н	L	Н	Y5 to Z
L	Н	Н	L	Y6 to Z
L	Н	Н	Н	Y7 to Z
Н	Х	Х	Х	switches off

[1] H = HIGH voltage level;

L = LOW voltage level;

X = don't care.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to V_{SS} = 0 V (ground).

Symbol	Parameter	Conditions		Min	Max	Unit
V _{CC}	supply voltage		[1]	-0.5	+7.0	V
I _{IK}	input clamping current	$V_{I} < -0.5$ V or $V_{I} > V_{CC}$ + 0.5 V	[2]	-	±20	mA
I _{SK}	switch clamping current	V_{SW} < –0.5 V or V_{SW} > V_{CC} + 0.5 V	[2]	-	±20	mA
I _{SW}	switch current	V_{SW} > -0.5 V or V_{SW} < V_{CC} + 0.5 V; source or sink current	[2]	-	±25	mA
T _{stg}	storage temperature			-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to +125 \ ^{\circ}C$	[3]			
		DIP16 package		-	750	mW
		SO16 package		-	500	mW
		TSSOP16 package		-	500	mW
		DHVQFN16 package		-	500	mW

[1] To avoid drawing V_{CC} current out of terminal Z, when switch current flows into terminals Yn, the voltage drop across the bidirectional switch must not exceed 0.4 V. If the switch current flows into terminal Z, no V_{CC} current will flow out of terminals Yn, and in this case there is no limit for the voltage drop across the switch, but the voltages at Yn and Z may not exceed V_{CC} or V_{EE} .

[2] The minimum input voltage rating may be exceeded if the input current rating is observed.

[3] For DIP16 packages: above 70 °C the value of P_{tot} derates linearly with 12 mW/K.
 For SO16 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K.
 For SSOP16 and TSSOP16 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K.
 For DHVQFN16 packages: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K.

74LV4051

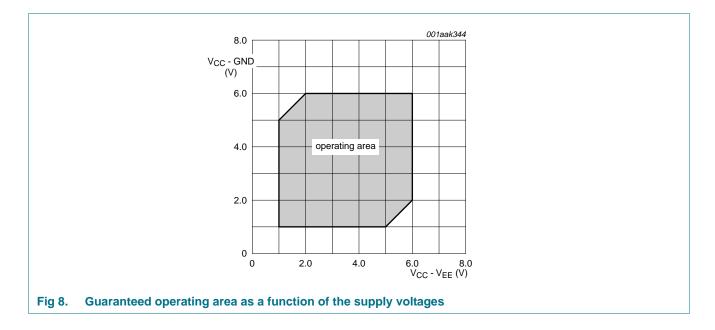
5 of 27

8-channel analog multiplexer/demultiplexer

Recommended operating conditions 8.

Table 5. Recommended operating conditions ^[1]										
Symbol	Parameter	Conditions	Min	Тур	Max	Unit				
V _{CC}	supply voltage	see Figure 8	1	3.3	6	V				
VI	input voltage		0	-	V _{CC}	V				
V _{SW}	switch voltage		0	-	V _{CC}	V				
T _{amb}	ambient temperature	in free air	-40	-	+125	°C				
$\Delta t / \Delta V$	input transition rise and fall rate	V _{CC} = 1.0 V to 2.0 V	-	-	500	ns/V				
		V_{CC} = 2.0 V to 2.7 V	-	-	200	ns/V				
		V _{CC} = 2.7 V to 3.6 V	-	-	100	ns/V				

[1] The static characteristics are guaranteed from V_{CC} = 1.2 V to 6.0 V, but LV devices are guaranteed to function down to V_{CC} = 1.0 V (with input levels GND or V_{CC}).



8-channel analog multiplexer/demultiplexer

9. Static characteristics

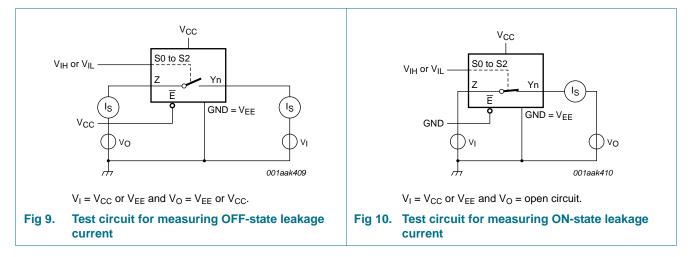
Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	–40 °C to	o +125 °C	Unit
			Min	Typ[1]	Max	Min	Max	
VIH	HIGH-level input voltage	V _{CC} = 1.2 V	0.9	-	-	0.9	-	V
		V _{CC} = 2.0 V	1.4	-	-	1.4	-	V
		V_{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
		V _{CC} = 4.5 V	3.15	-	-	3.15	-	V
		V _{CC} = 6.0 V	4.20	-	-	4.20	-	V
VIL	LOW-level input voltage	V _{CC} = 1.2 V	-	-	0.3	-	0.3	V
		V _{CC} = 2.0 V	-	-	0.6	-	0.6	V
		V_{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
		V _{CC} = 4.5 V	-	-	1.35	-	1.35	V
		V _{CC} = 6.0 V	-	-	1.80	-	1.80	V
li	input leakage current	$V_{I} = V_{CC}$ or GND						
	input leakage current	V _{CC} = 3.6 V	-	-	1.0	-	1.0	μΑ
		V _{CC} = 6.0 V	-	-	2.0		μΑ	
S(OFF)	OFF-state leakage current	$V_I = V_{IH}$ or V_{IL} ; see Figure 9						
		V _{CC} = 3.6 V	-	-	1.0	-	1.0	μΑ
		$V_{CC} = 6.0 V$	-	-	2.0	-	2.0	μΑ
S(ON)	ON-state leakage current	$V_I = V_{IH}$ or V_{IL} ; see Figure 10						
		V _{CC} = 3.6 V	-	-	1.0	-	1.0	μΑ
		$V_{CC} = 6.0 V$	-	-	2.0	-	2.0	μΑ
lcc	supply current	$V_I = V_{CC}$ or GND; $I_O = 0$ A						
		V _{CC} = 3.6 V	-	-	20	-	40	μΑ
		$V_{CC} = 6.0 V$	-	-	40	-	80	μΑ
∆l _{CC}	additional supply current	per input; V _I = V _{CC} – 0.6 V; V _{CC} = 2.7 V to 3.6 V	-	-	500	-	850	μA
CI	input capacitance		-	3.5	-	-	-	pF
C _{sw}	switch capacitance	independent pins Yn	-	5	-	-	-	pF
		common pin Z	-	25	-	-	-	pF

[1] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

8-channel analog multiplexer/demultiplexer



9.1 Test circuits

9.2 ON resistance

Table 7. ON resistance

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see $\frac{Figure 11}{Figure 12}$.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C t	o +125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	-
R _{ON(peak)}	ON resistance (peak)	$V_{I} = 0 V \text{ to } V_{CC} - V_{EE}$							
		V_{CC} = 1.2 V; I_{SW} = 100 μ A	[2]	-	-	-	-	-	Ω
		V_{CC} = 2.0 V; I_{SW} = 1000 μ A		-	145	325	-	375	Ω
		V_{CC} = 2.7 V; I_{SW} = 1000 μ A		-	90	200	-	235	Ω
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V;}$ $I_{SW} = 1000 \ \mu\text{A}$		-	80	180	-	210	Ω
		V_{CC} = 4.5 V; I _{SW} = 1000 µA		-	60	135	-	160	Ω
		V_{CC} = 6.0 V; I_{SW} = 1000 μ A		-	55	125	-	145	Ω
ΔR_{ON}	ON resistance mismatch	$V_I = 0 V \text{ to } V_{CC} - V_{EE}$							
	between channels	V_{CC} = 1.2 V; I_{SW} = 100 μ A	[2]	-	-	-	-	-	Ω
		V_{CC} = 2.0 V; I_{SW} = 1000 μ A		-	5	-	-	-	Ω
		V_{CC} = 2.7 V; I_{SW} = 1000 μ A		-	4	-	-	-	Ω
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V};$ $I_{SW} = 1000 \mu\text{A}$		-	4	-	-	-	Ω
		$V_{CC} = 4.5 \text{ V}; \text{ I}_{SW} = 1000 \mu\text{A}$		-	3	-	-	-	Ω
		$V_{CC} = 6.0 \text{ V}; I_{SW} = 1000 \mu\text{A}$		-	2	-	-	-	Ω

8-channel analog multiplexer/demultiplexer

Table 7. ON resistance ...continued

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for graphs see $\frac{Figure 11}{Figure 12}$.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to	o +125 °C	Unit
				Min	Typ[1]	Max	Min	Max	
R _{ON(rail)}	ON resistance (rail)	V _I = GND							
		V_{CC} = 1.2 V; I_{SW} = 100 μ A	[2]	-	225	-	-	-	Ω
		V_{CC} = 2.0 V; I_{SW} = 1000 μ A		-	110	235	-	270	Ω
		V_{CC} = 2.7 V; I_{SW} = 1000 μ A		-	70	145	-	165	Ω
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V};$ $I_{SW} = 1000 \ \mu\text{A}$		-	60	130	-	150	Ω
		V_{CC} = 4.5 V; I_{SW} = 1000 μ A		-	45	100	-	115	Ω
		$V_{CC} = 6.0 \text{ V}; \text{ I}_{SW} = 1000 \mu\text{A}$		-	40	85	-	100	Ω
R _{ON(rail)}	ON resistance (rail)	$V_I = V_{CC} - V_{EE}$							
		V_{CC} = 1.2 V; I_{SW} = 100 μ A	[2]	-	250	-	-	-	Ω
		V_{CC} = 2.0 V; I_{SW} = 1000 μ A		-	120	320	-	370	Ω
		V_{CC} = 2.7 V; I_{SW} = 1000 μ A		-	75	195	-	225	Ω
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V;}$ $I_{SW} = 1000 \mu\text{A}$		-	70	175	-	205	Ω
		V_{CC} = 4.5 V; I_{SW} = 1000 μ A		-	50	130	-	150	Ω
		$V_{CC} = 6.0 \text{ V}; \text{ I}_{SW} = 1000 \mu\text{A}$		-	45	120	-	135	Ω

[1] Typical values are measured at $T_{amb} = 25 \ ^{\circ}C$.

[2] When supply voltages (V_{CC} – V_{EE}) near 1.2 V the analog switch ON resistance becomes extremely non-linear. When using a supply of 1.2 V, it is recommended to use these devices only for transmitting digital signals.

8-channel analog multiplexer/demultiplexer

9.3 On resistance waveform and test circuit

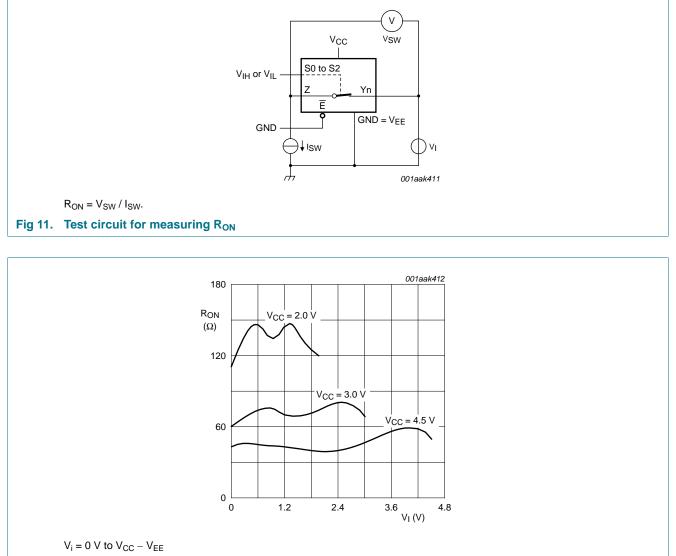


Fig 12. Typical R_{ON} as a function of input voltage

8-channel analog multiplexer/demultiplexer

10. Dynamic characteristics

Table 8. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 15.

Symbol	Parameter	Conditions		-40	°C to +85	5 °C	_40 °C t	o +125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Мах	-
t _{pd}	propagation delay	Yn to Z, Z to Yn; see Figure 13	[2]						
		V _{CC} = 1.2 V		-	25	-	-	-	ns
		V _{CC} = 2.0 V		-	9	17	-	20	ns
		V _{CC} = 2.7 V		-	6	13	-	15	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	<u>[3]</u>	-	5	10	-	12	ns
	V _{CC} = 4.5 V		-	4	9	-	10	ns	
		V _{CC} = 6.0 V		-	3	8	-	8	ns
t _{en}	enable time	E to Yn, Z; see Figure 14	[2]						
		V _{CC} = 1.2 V		-	145	-	-	-	ns
		V _{CC} = 2.0 V		-	49	94	-	112	ns
		V _{CC} = 2.7 V		-	36	69	-	83	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}; C_L = 15 \text{ pF}$	[3]	-	23	-	-	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	[3]	-	28	55	-	66	ns
		V _{CC} = 4.5 V		-	25	47	-	56	ns
		V _{CC} = 6.0 V		-	19	38	-	43	ns
		Sn to Yn; see <u>Figure 14</u>	[2]						
		V _{CC} = 1.2 V		-	140	-	-	-	ns
		V _{CC} = 2.0 V		-	48	90	-	107	ns
		V _{CC} = 2.7 V		-	35	66	-	79	ns
		$V_{CC} = 3.0 \text{ V}$ to 3.6 V; $C_L = 15 \text{ pF}$	<u>[3]</u>	-	22	-	-	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	<u>[3]</u>	-	27	53	-	63	ns
		V _{CC} = 4.5 V		-	24	45	-	54	ns
		$V_{CC} = 6.0 V$		-	18	34	-	41	ns

8-channel analog multiplexer/demultiplexer

Symbol	Parameter	Conditions		-40	°C to +85	S °C	−40 °C t	o +125 °C	Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{dis}	disable time	Ē to Yn, Z; see Figure 14	[2]						
		V _{CC} = 1.2 V		-	145	-	-	-	ns
		V _{CC} = 2.0 V		-	51	93	-	110	ns
		V _{CC} = 2.7 V		-	38	69	-	82	ns
		V_{CC} = 3.0 V to 3.6 V; C _L = 15 pF	<u>[3]</u>	-	25	-	-	-	ns
		V _{CC} = 3.0 V to 3.6 V	<u>[3]</u>	-	30	56	-	66	ns
		V _{CC} = 4.5 V		-	29	48	-	56	ns
		V _{CC} = 6.0 V		-	21	37	-	44	ns
		Sn to Yn; see <u>Figure 14</u>	[2]						
		V _{CC} = 1.2 V		-	115	-	-	-	ns
		V _{CC} = 2.0 V		-	41	73	-	90	ns
		V _{CC} = 2.7 V		-	31	54	-	67	ns
		V_{CC} = 3.0 V to 3.6 V; C _L = 15 pF	<u>[3]</u>	-	20	-	-	-	ns
		V _{CC} = 3.0 V to 3.6 V	<u>[3]</u>	-	24	44	-	54	ns
		V _{CC} = 4.5 V		-	22	37	-	46	ns
		V _{CC} = 6.0 V		-	17	29	-	36	ns
C _{PD}	power dissipation capacitance	C_L = 50 pF; f _i = 1 MHz; V ₁ = GND to V _{CC}	<u>[4]</u>	-	25	-	-	-	pF

Table 8. Dynamic characteristics ...continued

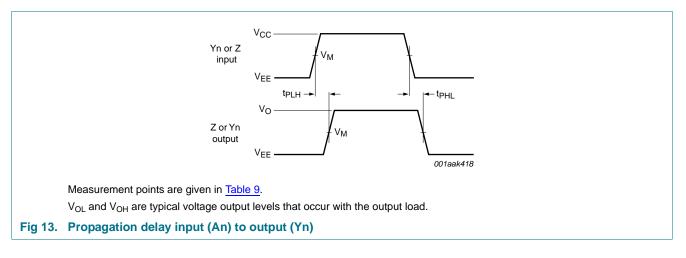
Voltages are referenced to GND (ground = 0 V). For test circuit see <u>Figure 15</u>.

[1] All typical values are measured at T_{amb} = 25 °C.

- [3] Typical values are measured at nominal supply voltage (V_{CC} = 3.3 V).
- $\begin{array}{ll} \label{eq:powerstar} [4] & C_{PD} \text{ is used to determine the dynamic power dissipation } (P_D \text{ in } \mu\text{W}). \\ & P_D = C_{PD} \times V_{CC}{}^2 \times f_i \times \text{N} + \Sigma((C_L + C_{SW}) \times V_{CC}{}^2 \times f_o) \text{ where:} \\ & f_i = \text{input frequency in } \text{MHz}, \ f_o = \text{output frequency in } \text{MHz} \\ & C_L = \text{output load capacitance in } \text{pF} \\ & C_{SW} = \text{maximum switch capacitance in } \text{pF}; \\ & V_{CC} = \text{supply voltage in } \text{Volts} \\ & \text{N} = \text{ number of inputs switching} \\ & \Sigma(C_L \times V_{CC}{}^2 \times f_o) = \text{sum of the outputs.} \end{array}$

8-channel analog multiplexer/demultiplexer

10.1 Waveforms



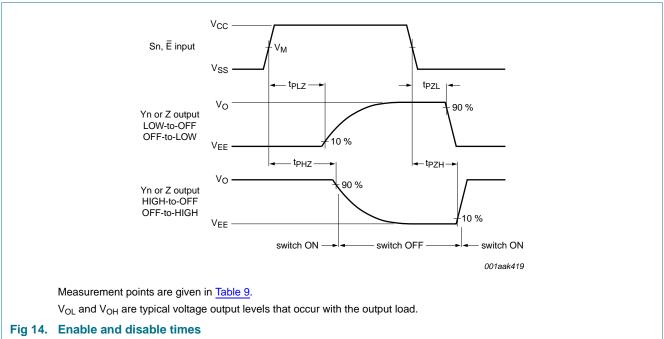


Table 9. **Measurement points**

Supply voltage	Input	Output	Output						
V _{cc}	V _M	V _M	V _X	V _Y					
< 2.7 V	0.5V _{CC}	0.5V _{CC}	V _{OL} + 0.1V _{CC}	$V_{OH} - 0.1V_{CC}$					
2.7 V to 3.6 V	1.5 V	1.5 V	V _{OL} + 0.3 V	V _{OH} – 0.3 V					
> 3.6 V	0.5V _{CC}	0.5V _{CC}	V _{OL} + 0.1V _{CC}	$V_{OH} - 0.1 V_{CC}$					

74LV4051

NXP Semiconductors

74LV4051

8-channel analog multiplexer/demultiplexer

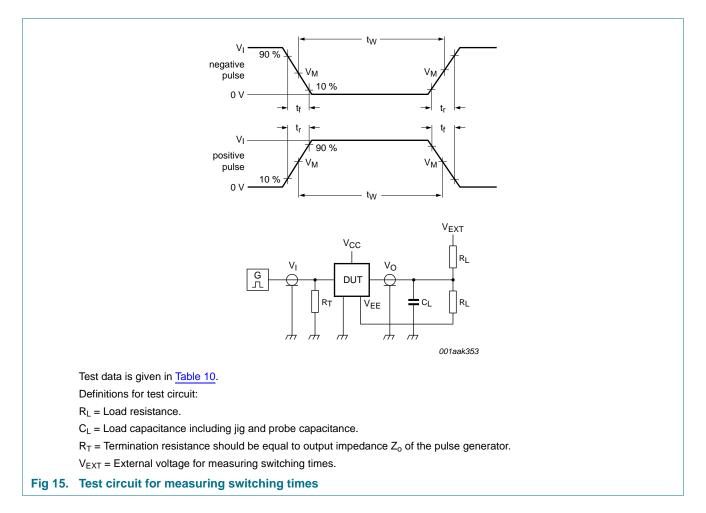


Table 10. Test data

Supply voltage	Input		Load		V _{EXT}			
V _{cc}	VI	t _r , t _f	CL	RL	t _{PHL} , t _{PLH}	t _{PZH} , t _{PHZ}	t _{PZL} , t _{PLZ}	
< 2.7 V	V _{CC}	≤ 6 ns	50 pF	1 kΩ	open	V _{EE}	2V _{CC}	
2.7 V to 3.6 V	2.7 V	≤ 6 ns	15 pF, 50 pF	1 kΩ	open	V _{EE}	2V _{CC}	
> 3.6 V	V _{CC}	≤6 ns	50 pF	1 kΩ	open	V _{EE}	2V _{CC}	

8-channel analog multiplexer/demultiplexer

10.2 Additional dynamic parameters

Table 11. Additional dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); $V_I = GND$ or V_{CC} (unless otherwise specified); $t_r = t_f \le 6.0$ ns; $T_{amb} = 25$ °C.

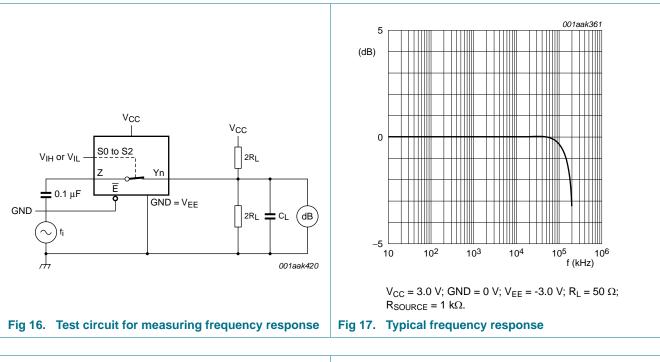
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
THD	total harmonic distortion	$f_i = 1 \text{ kHz}; C_L = 50 \text{ pF}; R_L = 10 \text{ k}\Omega; \text{ see } \frac{\text{Figure 20}}{10 \text{ km}}$					
		V _{CC} = 3.0 V; V _I = 2.75 V (p-p)		-	0.8	-	%
		V _{CC} = 6.0 V; V _I = 5.5 V (p-p)		-	0.4	-	%
		$f_i = 10 \text{ kHz}; C_L = 50 \text{ pF}; R_L = 10 \text{ k}\Omega; \text{ see } \frac{\text{Figure 20}}{10 \text{ kHz}}$					
		V _{CC} = 3.0 V; V _I = 2.75 V (p-p)		-	2.4	-	%
		V _{CC} = 6.0 V; V _I = 5.5 V (p-p)		-	1.2	-	%
f _(-3dB)	-3 dB frequency response	$C_L = 50 \text{ pF}; R_L = 50 \Omega; \text{ see } \frac{\text{Figure 16}}{1000}$	[1]				
		V _{CC} = 3.0 V		-	180	-	MHz
		V _{CC} = 6.0 V		-	200	-	MHz
α_{iso}	isolation (OFF-state)	$f_i = 1 \text{ MHz}; C_L = 50 \text{ pF}; R_L = 600 \Omega; \text{ see } \frac{\text{Figure } 18}{18}$	[2]				
		V _{CC} = 3.0 V		-	-50	-	dB
		V _{CC} = 6.0 V		-	-50	-	dB
V _{ct}	crosstalk voltage	between digital inputs and switch; $f_i = 1 \text{ MHz}$; C _L = 50 pF; R _L = 600 Ω; see Figure 21	[2]				
		V _{CC} = 3.0 V		-	0.11	-	V
		$V_{CC} = 6.0 V$		-	0.12	-	V
Xtalk	crosstalk	between switches; $f_i = 1 \text{ MHz}$; $C_L = 50 \text{ pF}$; $R_L = 600 \Omega$; see <u>Figure 22</u>					
		V _{CC} = 3.0 V		-	-60	-	dB
		$V_{CC} = 6.0 V$		-	-60	-	dB

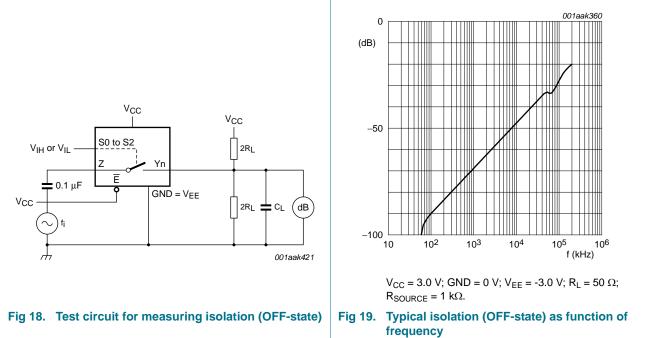
[1] Adjust f_i voltage to obtain 0 dBm level at output for 1 MHz (0 dBm = 1 mW into 50 Ω).

[2] Adjust f_i voltage to obtain 0 dBm level at output for 1 MHz (0 dBm = 1 mW into 600 Ω).

8-channel analog multiplexer/demultiplexer





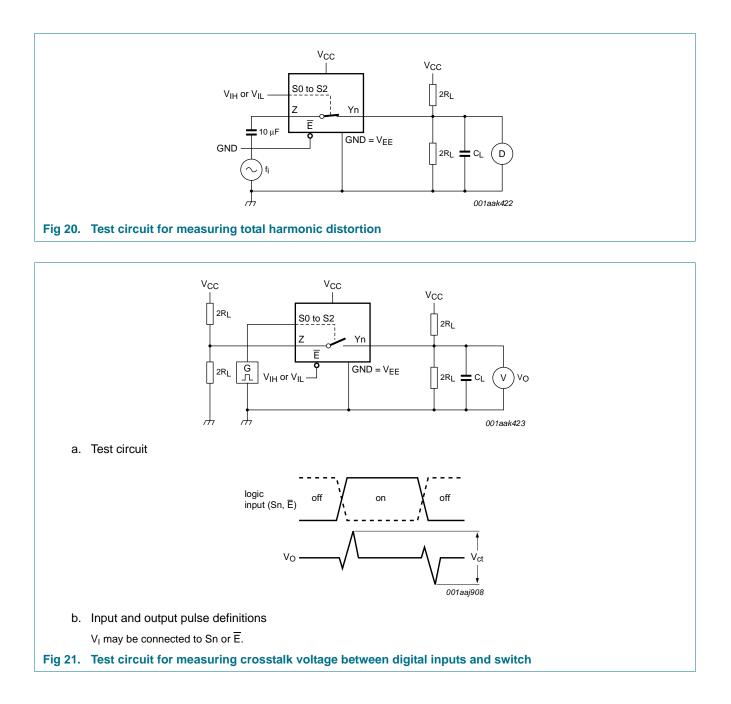


16 of 27

NXP Semiconductors

74LV4051

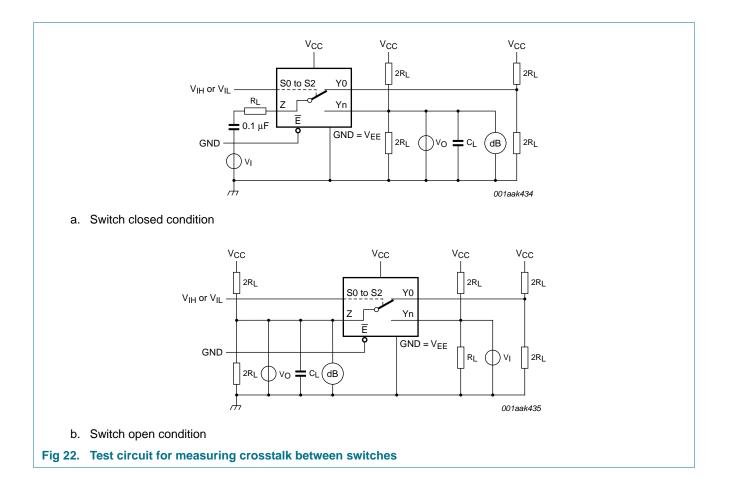
8-channel analog multiplexer/demultiplexer



NXP Semiconductors

74LV4051

8-channel analog multiplexer/demultiplexer



8-channel analog multiplexer/demultiplexer

11. Package outline

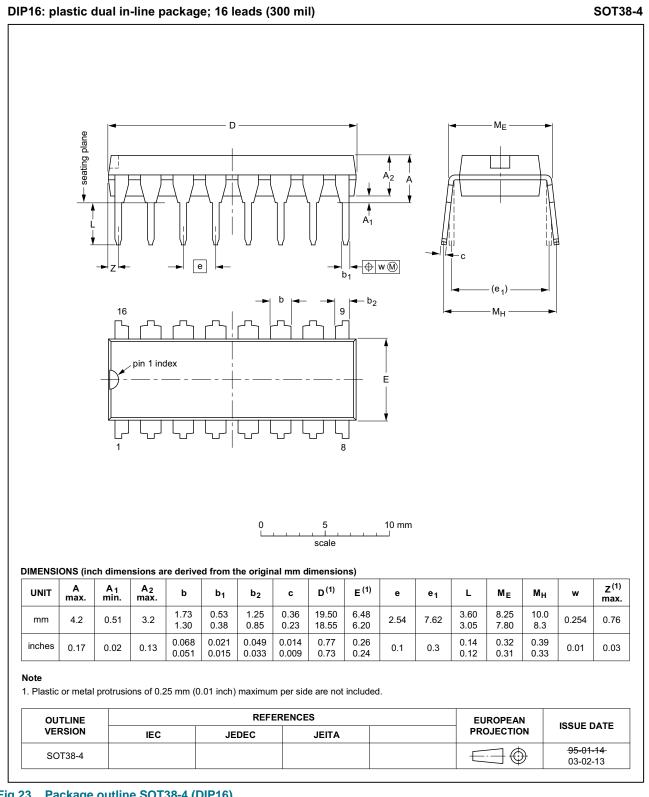


Fig 23. Package outline SOT38-4 (DIP16)

8-channel analog multiplexer/demultiplexer

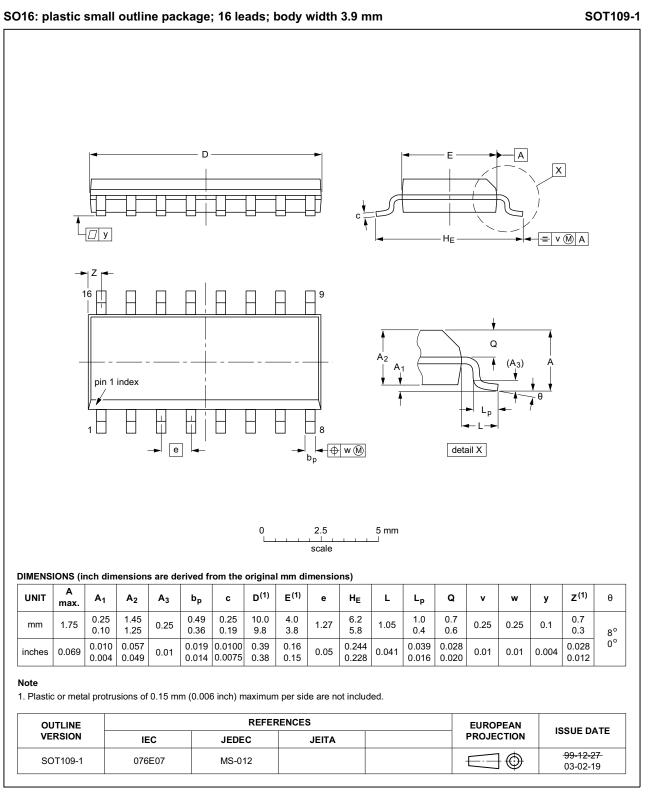


Fig 24. Package outline SOT109-1 (SO16)

8-channel analog multiplexer/demultiplexer

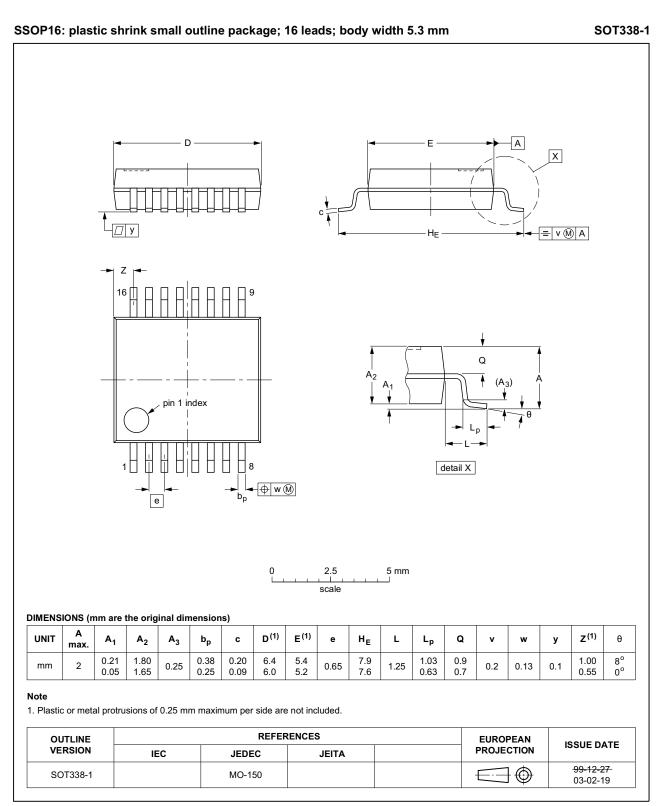


Fig 25. Package outline SOT338-1 (SSOP16)

All information provided in this document is subject to legal disclaimers.

8-channel analog multiplexer/demultiplexer

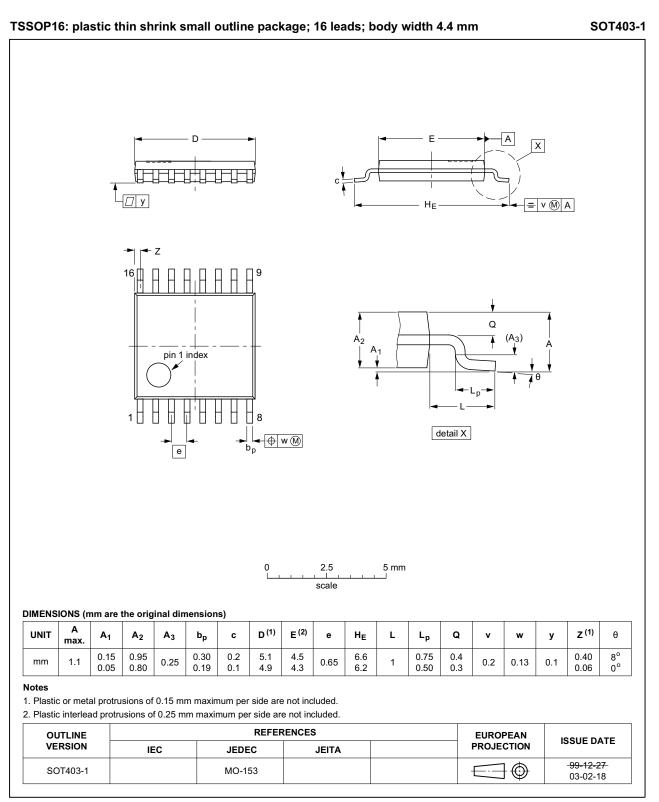
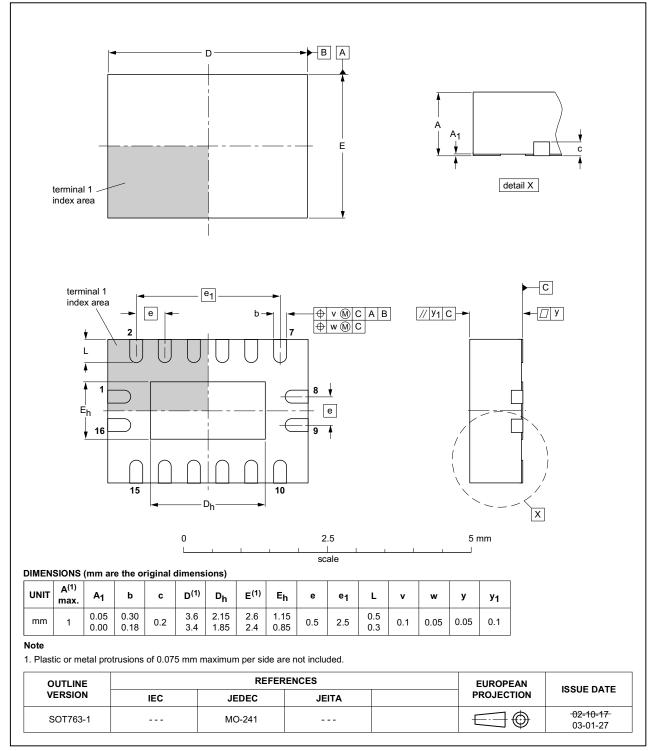


Fig 26. Package outline SOT403-1 (TSSOP16)

All information provided in this document is subject to legal disclaimers.

8-channel analog multiplexer/demultiplexer



DHVQFN16: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 16 terminals; body 2.5 x 3.5 x 0.85 mm SOT763-1

Fig 27. Package outline SOT763-1 (DHVQFN16)

All information provided in this document is subject to legal disclaimers.

8-channel analog multiplexer/demultiplexer

12. Abbreviations

Table 12. Abbreviations			
Acronym	Description		
CMOS	Complementary Metal-Oxide Semiconductor		
ESD	ElectroStatic Discharge		
НВМ	Human Body Model		
MM	Machine Model		
TTL	Transistor-Transistor Logic		

13. Revision history

Table 13.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes			
74LV4051 v.5	20140917	Product data sheet	-	74LV4051 v.4			
Modifications:	<u>Figure 7</u> : Figure note added for DHVQFN16 package						
74LV4051 v.4	20090810	Product data sheet	-	74LV4051 v.3			
Modifications:	Indifications: • The format of this data sheet has been redesigned to comply with the new identity guing of NXP Semiconductors.						
	 Legal texts have been adapted to the new company name where appropriate. 						
	 Added type number 74LV4051BQ (DHVQFN16 package) 						
74LV4051 v.3	19960623	Product specification	-	74LV4051 v.2			
74LV4051 v.2	19970715	Product specification	-	74LV4051 v.1			

24 of 27

8-channel analog multiplexer/demultiplexer

14. Legal information

14.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

14.2 Definitions

Draft — The document is a draft version only. The content is still under internal review and subject to formal approval, which may result in modifications or additions. NXP Semiconductors does not give any representations or warranties as to the accuracy or completeness of information included herein and shall have no liability for the consequences of use of such information.

Short data sheet — A short data sheet is an extract from a full data sheet with the same product type number(s) and title. A short data sheet is intended for quick reference only and should not be relied upon to contain detailed and full information. For detailed and full information see the relevant full data sheet, which is available on request via the local NXP Semiconductors sales office. In case of any inconsistency or conflict with the short data sheet, the full data sheet shall prevail.

Product specification — The information and data provided in a Product data sheet shall define the specification of the product as agreed between NXP Semiconductors and its customer, unless NXP Semiconductors and customer have explicitly agreed otherwise in writing. In no event however, shall an agreement be valid in which the NXP Semiconductors product is deemed to offer functions and qualities beyond those described in the Product data sheet.

14.3 Disclaimers

Limited warranty and liability — Information in this document is believed to be accurate and reliable. However, NXP Semiconductors does not give any representations or warranties, expressed or implied, as to the accuracy or completeness of such information and shall have no liability for the consequences of use of such information. NXP Semiconductors takes no responsibility for the content in this document if provided by an information source outside of NXP Semiconductors.

In no event shall NXP Semiconductors be liable for any indirect, incidental, punitive, special or consequential damages (including - without limitation - lost profits, lost savings, business interruption, costs related to the removal or replacement of any products or rework charges) whether or not such damages are based on tort (including negligence), warranty, breach of contract or any other legal theory.

Notwithstanding any damages that customer might incur for any reason whatsoever, NXP Semiconductors' aggregate and cumulative liability towards customer for the products described herein shall be limited in accordance with the *Terms and conditions of commercial sale* of NXP Semiconductors.

Right to make changes — NXP Semiconductors reserves the right to make changes to information published in this document, including without limitation specifications and product descriptions, at any time and without notice. This document supersedes and replaces all information supplied prior to the publication hereof. Suitability for use — NXP Semiconductors products are not designed, authorized or warranted to be suitable for use in life support, life-critical or safety-critical systems or equipment, nor in applications where failure or malfunction of an NXP Semiconductors product can reasonably be expected to result in personal injury, death or severe property or environmental damage. NXP Semiconductors and its suppliers accept no liability for inclusion and/or use of NXP Semiconductors products in such equipment or applications and therefore such inclusion and/or use is at the customer's own risk.

Applications — Applications that are described herein for any of these products are for illustrative purposes only. NXP Semiconductors makes no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

Customers are responsible for the design and operation of their applications and products using NXP Semiconductors products, and NXP Semiconductors accepts no liability for any assistance with applications or customer product design. It is customer's sole responsibility to determine whether the NXP Semiconductors product is suitable and fit for the customer's applications and products planned, as well as for the planned application and use of customer's third party customer(s). Customers should provide appropriate design and operating safeguards to minimize the risks associated with their applications and products.

NXP Semiconductors does not accept any liability related to any default, damage, costs or problem which is based on any weakness or default in the customer's applications or products, or the application or use by customer's third party customer(s). Customer is responsible for doing all necessary testing for the customer's applications and products using NXP Semiconductors products in order to avoid a default of the applications and the products or of the application or use by customer's third party customer(s). NXP does not accept any liability in this respect.

Limiting values — Stress above one or more limiting values (as defined in the Absolute Maximum Ratings System of IEC 60134) will cause permanent damage to the device. Limiting values are stress ratings only and (proper) operation of the device at these or any other conditions above those given in the Recommended operating conditions section (if present) or the Characteristics sections of this document is not warranted. Constant or repeated exposure to limiting values will permanently and irreversibly affect the quality and reliability of the device.

Terms and conditions of commercial sale — NXP Semiconductors products are sold subject to the general terms and conditions of commercial sale, as published at http://www.nxp.com/profile/terms, unless otherwise agreed in a valid written individual agreement. In case an individual agreement is concluded only the terms and conditions of the respective agreement shall apply. NXP Semiconductors hereby expressly objects to applying the customer's general terms and conditions with regard to the purchase of NXP Semiconductors products by customer.

No offer to sell or license — Nothing in this document may be interpreted or construed as an offer to sell products that is open for acceptance or the grant, conveyance or implication of any license under any copyrights, patents or other industrial or intellectual property rights.

© NXP Semiconductors N.V. 2014. All rights reserved.

8-channel analog multiplexer/demultiplexer

Export control — This document as well as the item(s) described herein may be subject to export control regulations. Export might require a prior authorization from competent authorities.

Non-automotive qualified products — Unless this data sheet expressly states that this specific NXP Semiconductors product is automotive qualified, the product is not suitable for automotive use. It is neither qualified nor tested in accordance with automotive testing or application requirements. NXP Semiconductors accepts no liability for inclusion and/or use of non-automotive qualified products in automotive equipment or applications.

In the event that customer uses the product for design-in and use in automotive applications to automotive specifications and standards, customer (a) shall use the product without NXP Semiconductors' warranty of the product for such automotive applications, use and specifications, and (b) whenever customer uses the product for automotive applications beyond

NXP Semiconductors' specifications such use shall be solely at customer's own risk, and (c) customer fully indemnifies NXP Semiconductors for any liability, damages or failed product claims resulting from customer design and use of the product for automotive applications beyond NXP Semiconductors' standard warranty and NXP Semiconductors' product specifications.

Translations — A non-English (translated) version of a document is for reference only. The English version shall prevail in case of any discrepancy between the translated and English versions.

14.4 Trademarks

Notice: All referenced brands, product names, service names and trademarks are the property of their respective owners.

15. Contact information

For more information, please visit: http://www.nxp.com

For sales office addresses, please send an email to: salesaddresses@nxp.com

8-channel analog multiplexer/demultiplexer

16. Contents

1	General description	1
2	Features and benefits	1
3	Ordering information	2
4	Functional diagram	2
5	Pinning information	4
5.1 5.2	·	4 4
6	•	5
6.1	Function table	-
7		5
8	-	6
9	Static characteristics	7
9.1		8
9.2		8
9.3	On resistance waveform and test circuit 1	0
10	Dynamic characteristics 1	1
10.1	Waveforms	3
10.2	Additional dynamic parameters 1	-
10.2.1	Test circuits 10	-
11	Package outline 1	-
12	Abbreviations 24	4
13	Revision history 2	-
14	Legal information 2	5
14.1	Data sheet status 2	-
14.2	Definitions	-
14.3 14.4	Disclaimers	-
	Trademarks	-
15	Contact information	-
16	Contents 2	7

Please be aware that important notices concerning this document and the product(s) described herein, have been included in section 'Legal information'.

© NXP Semiconductors N.V. 2014.

All rights reserved.

For more information, please visit: http://www.nxp.com For sales office addresses, please send an email to: salesaddresses@nxp.com

Date of release: 17 September 2014 Document identifier: 74LV4051

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

NXP:

74LV4051D-T 74LV4051DB-T 74LV4051N 74LV4051N,112 74LV4051D/AUJ 74LV4051PW/AUJ